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Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label</th>
<th>Part Number</th>
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<tbody>
<tr>
<td>001</td>
<td>LBL1</td>
<td>BQ76PL536ATPAPRQ1</td>
</tr>
<tr>
<td>002</td>
<td>LBL2</td>
<td>BQ76PL536ATPAPR</td>
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</tbody>
</table>

CAUTION 1
DANGEROUS HIGH VOLTAGE

Assembly Note
ZZ1
This Assembly Note is for PCB labels only.

Assembly Note
ZZ2
These assemblies are ESD sensitive. ESD precautions shall be observed.

Assembly Note
ZZ3
These assemblies must be clean and free of flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note
ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Assembly Note
ZZ5
Please plug P9- Terminal, P10- Terminal, P11- Terminal to P1, P2, P3
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